









Features:

- Solid body structure, sealed for harsh environments
- High interrupting ratings for excellent inrush current capability
- High reliability for long time operation
- Current ratings from 20A to 125A at 2822 case size
- Voltage ratings from 48Vdc to 125Vdc
- Automotive grade with AEC-Q200 qualification
- Halogen free, RoHS compliant and 100% lead-free

Clearing Time Characteristics:

| of Current Beting | Clearing Time at 25°C | | |
|---------------------|-----------------------|------------|--|
| % of Current Rating | Min. | Max. | |
| 100% | 4 hours | | |
| 250% | | 60 seconds | |

Shape and Dimensions:

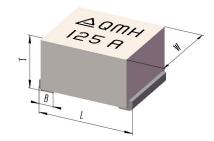
| Unit | Inch | mm |
|------|---------------|---------------|
| L | 0.287 ± 0.012 | 7.3 ± 0.3 |
| W | 0.228 ± 0.008 | 5.8 ± 0.2 |
| Т | 0.165 ± 0.008 | 4.2 ± 0.2 |
| В | 0.051 ± 0.012 | 1.3 ± 0.3 |

Applications:

- Server Systems
- UPS & Routers and Switches
- Telecom DC/DC Power
- Drones
- Power tools
- EV Battery Power Systems

Agency Approval:

Recognized Under the Components Program of Underwriters Laboratories. File Number: E507943.



Ordering Information:

| Part Number | Current Rating (A) | Voltage Rating (Vdc) | Interrupting Rating | Nominal DCR (mΩ) ¹ | Nominal I ² t (A ² s) ² | Marking ⁴ |
|--------------|-----------------------|--|--|----------------------------------|--|----------------------|
| QM2822H20A0T | 20 | | | In Pending | NA | NA |
| QM2822H30A0T | 30 | 300A @125Vdc 1,000A @ 75Vdc ³ 1,500A @ 48Vdc ³ | In Pending | NA | NA | |
| QM2822H40A0T | 40 | | 1.05 | 400 | △QMH 40 A | |
| QM2822H50A0T | 50 | | | 0.85 | 600 | △QMH 50 A |
| QM2822H60A0T | 60 | | | 0.74 | 900 | △QMH 60 A |
| QM2822H70A0T | 70 | 75 | | 0.61 | 1,400 | △QMH 70 R |
| QM2822H80A0T | 80 | | 1,000A @ 75Vdc ³ 1,500A @ 48Vdc ³ | 0.53 | 2,000 | △QMH 80 A |
| QM2822H90A0T | 90 | | 1,500A @ 48Vdc ³ | 0.48 | 2,400 | ≙QMH 90 R |
| QM2822H100AT | 100 | | | 0.44 | 3,600 | △QMH IOO A |
| QM2822H125AT | 125 |] | | 0.38 | 6,000 | △QMH 125 A |

- 1. Measured at ≤10% rated current and 25 °C ambient
- 2. Melting I²t at 10x In
- 3. Time constant of interrupting test less than 0.1ms
- 4. Black marketing character code or laser marking code

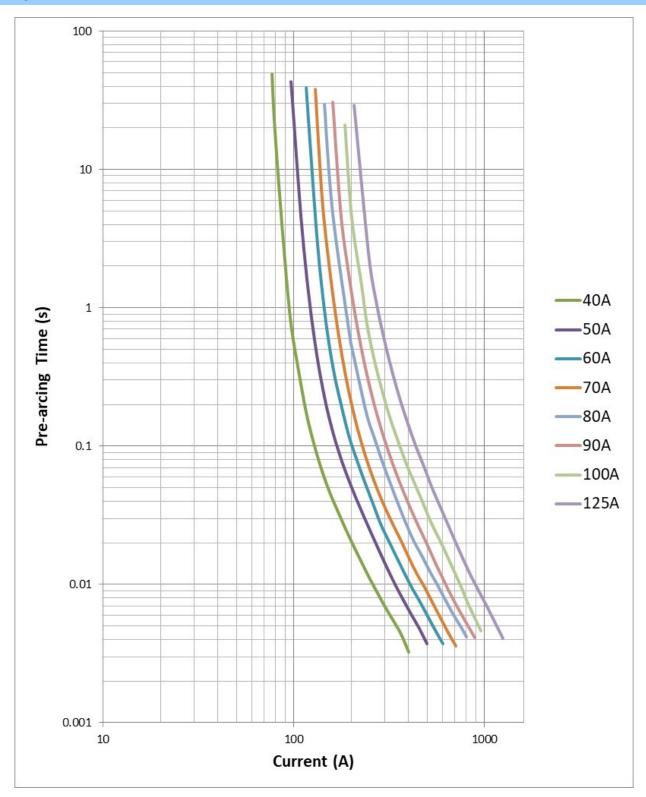








Clearing Time vs. Current Curves:



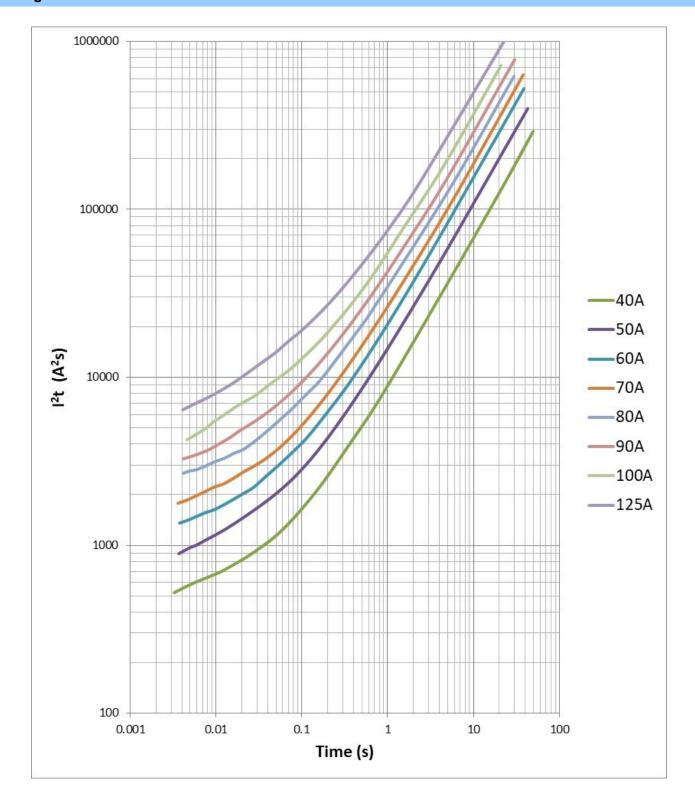








Average I²t vs. t Curves:











Product Identification:

 $\frac{QM}{(1)}$ $\frac{2822}{(2)}$ $\frac{H}{(3)}$ $\frac{60A0}{(4)}$ $\frac{T}{(5)}$

(1) Product Code: QM-Automotive Molding Fuse

(2) Size code: L x W (inch): the first two digits - L (length), the last

two digits - W (width)
(3) Series code: H

(4) Current rating code: e.g. 60A0: 60.0A

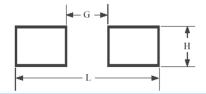
(5) Package code: T - Tape & Reel, B - Bulk

Marking: Top Line: △ AEM Logo; QMH: QM2822H Series

Bottom Line: Current Rating Code

Recommended Land Pattern:

| Chip Size | 2822 (7358) |
|-------------|-------------|
| L Inch (mm) | 0.386 (9.8) |
| G Inch (mm) | 0.173 (4.4) |
| H Inch (mm) | 0.228 (5.8) |



Reliability Tests:

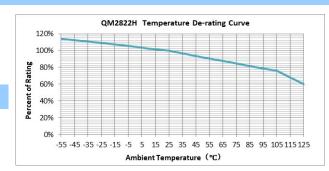
| ltem | Test Condition | Criteria | |
|------------------------------------|---|---|--|
| High temperature storage | Subject fuses to +125°C for 1000 hours | DCR change within ±20%, no observed damage | |
| Low temperature storage | Subject fuses to -65°C for 1000 hours | DCR change within ±20%, no observed damage | |
| Temperature Cycling | Subject fuses to 1000 temperature cycles, 30min at -65°C lowest temp and 30min at +125°C highest temp | DCR change within ±20%, no mechanical damage | |
| Biased Humidity | Subject fuses to +85°C/85%RH with 10% rated current for 1000 hours | DCR change within ±20%, no excessive corrosion | |
| High Temperature Operating Life | +125°C for 1000 hours. Load setting : 75%(current derating)*60%(temp. de-rating)*Rated current | DCR change within ±20%, no observed damage | |
| Mechanical Vibration | 0.4" D.A. or 30G between 5 and 3000 Hz, along 3 mutually perpendicular axes for a total of 12 hours | DCR change within ±20%, no mechanical damage | |
| Mechanical Shock | 1500G, 0.5 ms, half sine shocks in 6 major directions along 3 mutually perpendicular axes | DCR change within ±20%, no mechanical damage | |
| Resistance to Soldering Heat | One dip at 260°C, 10 seconds | DCR change within ±20%, new solder coverage 75% minimum, no mechanical damage | |
| Salt Spray | 5% salt solution, 48 hours exposure | DCR change within ±20%, no excessive corrosion | |
| Solderability | 245°C, 5 seconds | New solder coverage 95% minimum | |
| Terminal Strength | Apply 17.7N (1.8kg) force gradually to the side of the fuse, this force shall be applied for 60 seconds | DCR change within ±20%, no mechanical damage | |
| Board Flex | Apply a force that will bend the board distance of x=2mm, and the duration of the applied force shall be 60 seconds | DCR change within ±20%, no mechanical damage | |

Fuse Selection and Temperature De-rating Guideline:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than $25\,^\circ\text{C}$, the fuse shall be "de-rated" according to the de-rating curve.

Packaging:

| Chip Size | Parts on 13 inch (330 mm) Reel |
|-----------|--------------------------------|
| 2822 | 1,000 pcs |

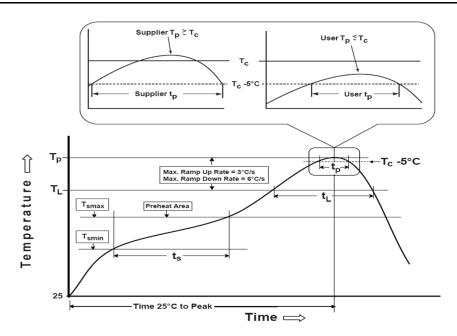






Recommended Temperature Profile for Reflow Soldering:

| Profile Feature | Pb-Free Assembly | |
|---|----------------------------------|--|
| $ \begin{array}{l} \textbf{Preheat/Soak} \\ \textbf{Temperature Min (T_{smin})} \\ \textbf{Temperature Max (T_{smax})} \\ \textbf{Time (t_s) from (T_{smin} to T_{smax})} \end{array} $ | 150°C 200°C 60~120 seconds | |
| Ramp-uprate (T _L to T _p) | 3°C/second max. | |
| Liquidous temperature (T_L) Time(t_L) maintained above T_L | 217°C 60~150 seconds | |
| Peak package body temperature (T _p) | 260°C | |
| Time $(t_p)^*$ within 5°C of the specified classification temperature (T_c) | 30 seconds * | |
| Ramp-down rate $(T_p \text{ to } T_L)$ | 6°C/second max. | |
| Time 25°C to peak temperature | 8 minutes max. | |
| * Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum | | |



Recommended conditions for hand soldering:

- 1. Appropriate temperature (max.) of soldering iron tip/soldering time (max.): 280°C /10 s or 350°C / 3 s
- 2. Using hot air rework station with tip that can melt the solder on both terminations at the same time is strongly recommended. Do not directly contact the chip termination with the tip of soldering iron.

Storage:

- The maximum ambient temperature shall not exceed 35°C. Storage temperatures higher than 35°C could result in the deformation of packaging materials.
- 2. The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.
- 3. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.
- 4. MSL=1





Disclaimer

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